

# INNOVATIVE HYDROMETALLURGICAL TREATMENTS OF WEEE

**SOS.TE.N.ERE**

**ITIA-CNR**  
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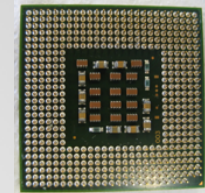
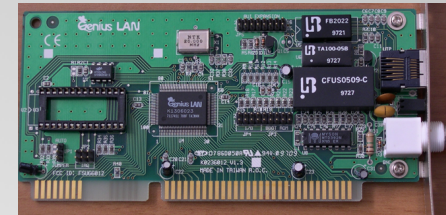
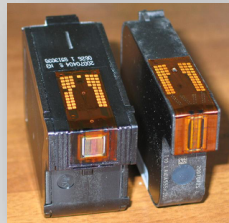
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- NM are crucial components of several **E**lectric and **E**lectronic **E**quipments (**EEE**)



**Au**

**Pd**

**Cu**

**Ag**

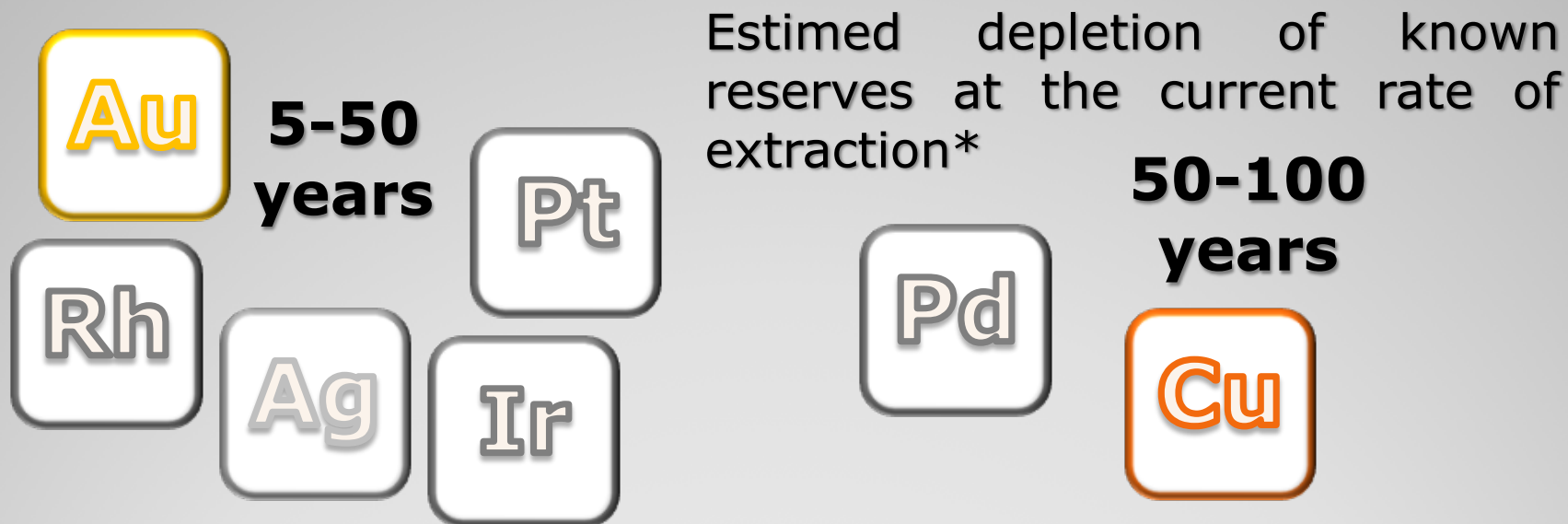
**Ir**

**Rh**

**Pt**

**Noble-Metals (NM) based technologies**

- NM reserves will be depleted in few years



- Most of them are listed as critical metals by EU\*\*

\*RSC Green Chemistry Element Recovery and Sustainability, N. 22, 2013, Chapter 1, Hunt

\*\*Report of the Ad-hoc Working Group on defining critical raw materials, 30 July 2010 and May 2014.

**Estimated depletion of raw materials**

- **No longer working**
- **no longer interesting**
- **no longer performing**

**... Hi-Tech goods!**



- Fast technological development → Reduces lifespan & increases demand for Hi-Tech goods
- Planned obsolescence

**High rate of element  
consumption  
& WEEE accumulation**



**2014**  
**41.8M t/year worldwide**  
(5% all municipal waste)  
**9.1M t/year in EU**  
**3-5% growth/year**

**Waste EEE (WEEE)**

The worldwide fastest growing  
waste stream!



General scope: preserving the environment and natural sources;  
limiting or avoiding hazardous substances

Objective: limiting WEEE to be disposed of, by promoting recovery.

### EU waste management priorities:

- **prevention or reduction of waste**
  - **recovery of waste**
  - **waste as a source of energy**
- improved by:
- product design to limit hazardous substances and favour material recovery.
  - safe processes for waste recovery or disposal.

### *European Directives:*

*91/156/EC on waste management*

*2012/19/EU on WEEE*

*2011/65/EU on restriction of the use of certain hazardous substances in EEE (RoHS)*

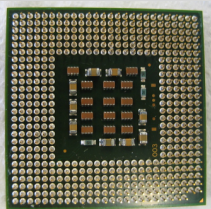
***“polluter pays” and  
“producer responsibility”  
principles***

**Collection rate: 85% of generated WEEE (~20Kg/year per capita)**

## EU Directives on Waste Management

## "Urban mine"

- PBCs  **50-700g/t**

- CPUs  **4Kg/t**

- Sim and smart cards



**1Kg/t**

- Printer cartridges



**100g/t**



## Gold mine

Costs for metal extraction:  
**385 \$/oz (15 euro/g)**



*Gold mine in  
Sardinia:  
**2-4 g/t Au***



# Gold in WEEE vs MINES

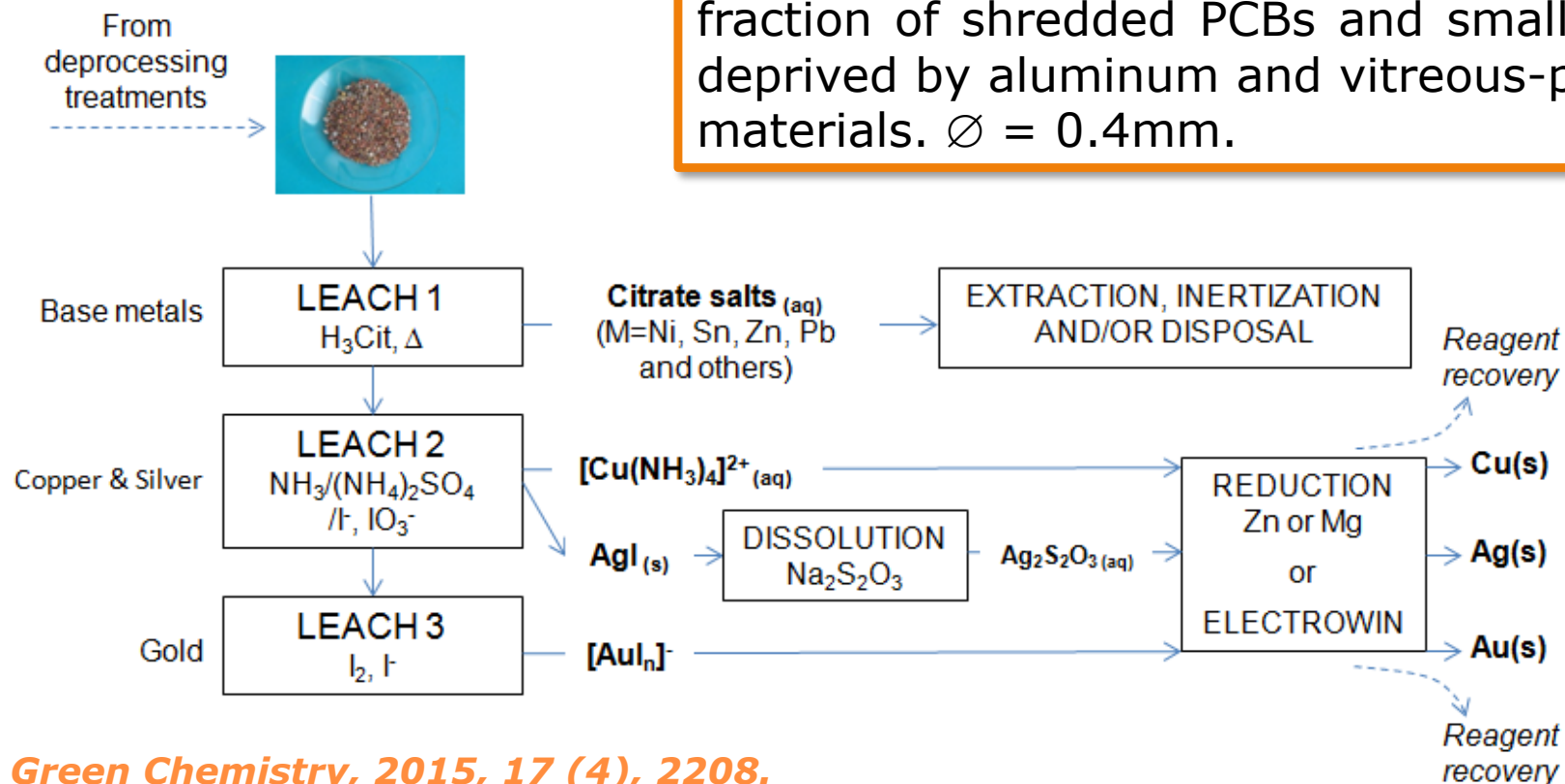
- **WEEE are valuable secondary source of NMs**
- **“Volatile” quotation and high price (euro/g, 28/01/'18):  
Au 35; Rh 44; Pt 26; Pd 28; Ag 0.45**
- **Recovery rates of NMs from wastes still too low  
~ 30% Au; 12% Ag; 27% Pd; 22% Pt, in 2015**
- **NMs recovery from WEEE mainly performed by using hazardous and/or polluting processes “inherited” by ore reclamation**

NEED OF

Robust, versatile and “green” processes to achieve economical-technical-environmental sustainability for NMs recovery in a Circular Economy model.

**From “trash” to “resource”**

Test specimen: non-ferrous metallic fraction of shredded PCBs and small EEE, deprived by aluminum and vitreous-plastic materials.  $\varnothing = 0.4\text{mm}$ .



- NM recovery occurs in an almost quantitative yield
- Reagents can be recycled
- Safe reagents and mild reaction conditions



**Sustainable NM recovery method for WEEE**



# Jointly by companies:



Activity		Phase
Selection of PBCs as target WEEE	Abundant and NM-rich waste stream	
Characterization of the different typologies of existing PCBs	Lack of a robust and detailed database	<b>1</b>
Selection of the target PCB	In terms of NM content and sample availability	
Collection and shredding of the test specimen	Low cost milling treatment	<b>2</b>
NM Leaching & recovery process	Effect of grain size and interfering materials	
Scale-up on pilot plant	#R #G #M	<b>3</b>

## Technology transfer

- Selection and pre-treatments

Typology	n.	Weight after shredding			Weight loss %	Elements removed before shredding
		Starting weight [g]	First stage [g]	Second stage [g]		
DVD/CD players PCBs	7	220,0	220,0	214,8	2,1	Motors and rotating supports (334 g)
NICs <sup>a</sup>	13	642,6	639,6	635,1	1,2	Fasteners (14,4 g)
RAM <sup>b</sup> white fingers	50	703,3		702,6	0,1	
RAM <sup>b</sup> gold fingers	40	676,5		667,1	1,4	
Hard drive PCBs	5	98,3	98,0	95,5	2,9	Heads and motors (768.3 g)
Mother boards <sup>c</sup>	5	2525,4	2510,8	2486,7	1,5	
TV PCBs	5	1985,3		1947,4	1,9	Ferrous parts (142,3 g)
Mobile phone PCBs	30	695,7		694,1	0,2	

<sup>a</sup>Network Integrated Controllers; <sup>b</sup>Random Access Memories; <sup>c</sup>Shredded with connectors

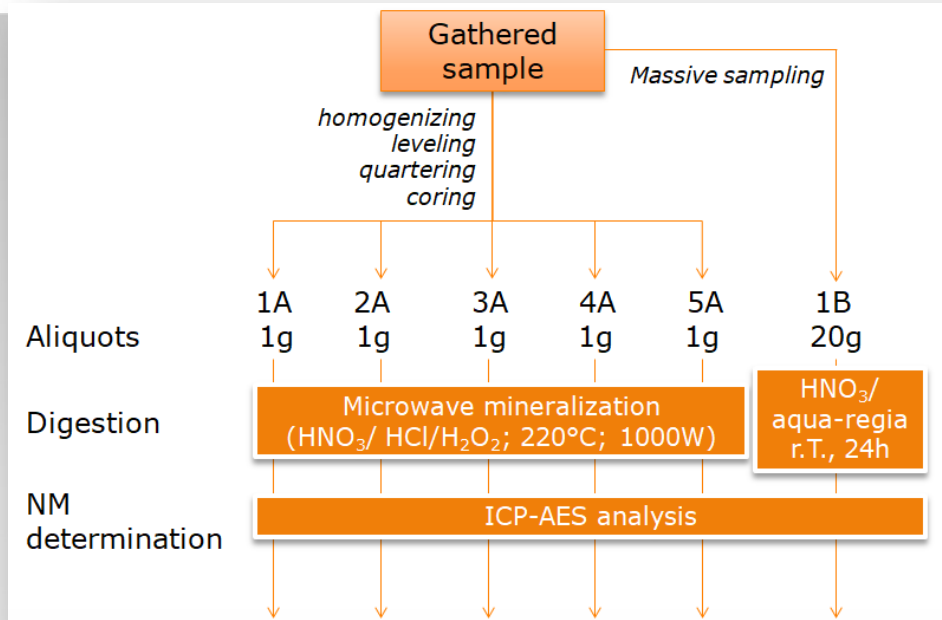
1st stage: single shaft shredder comminution (output:  $\varnothing = 10\text{mm}$ ).

2nd stage: cutting mill (1500 rpm; meshed grid: 2 mm, hardmetal tools).

Internal cleaning of the machine was performed after each treatment, in order to avoid contamination and loss of precious materials.

## Phase 1: Characterization of PCBs

- Sampling
- Digestion
- ICP-AES analysis



Sample	NMs content - %(SD)			
	Pd	Au	Ag	Cu
DVD/CD players PCBs	<0.01*	0.01(±0.01)	0.08(±0.05)	16.2(±4.4)
NICs	<0.01*	0.02(±0.01)	0.03(±0.01)	19.1(±2.3)
RAM white fingers	0.04(±0.03)	0.03(±0.01)	0.10(±0.06)	16.6(±1.9)
RAM gold fingers	0.01(±0.01)	0.07(±0.01)	0.05(±0.01)	17.1(±1.2)
Hard drive PCBs	0.02(±0.02)	0.03(±0.01)	0.06(±0.05)	23.6(±4.9)
Mother boards	<0.01*	0.01(±0.01)	0.04(±0.02)	26.7(±5.4)
TV PCBs	<0.01*	<0.01*	0.03 (±0.01)	13.0(±7.4)
Mobile phone PCBs	0.06(±0.02)	0.07 (±0.01)	0.14 (±0.25)	33.8(±1.1)

\*The concentration of this element is lower than the Limit of Detection of the measure.

## Phase 1: Characterization of PCBs

## • Shredding



Mix RAMs  
200g

### Ball milling

- 24h, r.T.
- stainless steel jar planetary apparatus: 4-stages mill, 300rpm
- hardmetal balls: Ø 6 mm, 1.4Kg
- Carbsyn: 250mL



## • Characterization

Wide particle size dispersion:

106g Ø <2mm

94g Ø >2mm


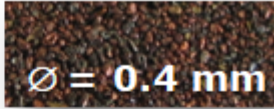
Presence of composite vitreous-plastic material

- ICP-AES analysis on N. 3 aliquotes (1.5g each) digested under microwaves
- High SD→heterogeneous material

Element	RAM #R#G#M Content %(SD)
Au	0.08 (±0.03)
Ag	0.04 (±0.01)
Pd	0.06 (±0.04)
Cu	15 (±1)
Ni	4.2 (±0.7)
Fe	7 (±3)
Cr	<0.01
Mn	0.06 (±0.02)
Pb	0.8 (±0.5)

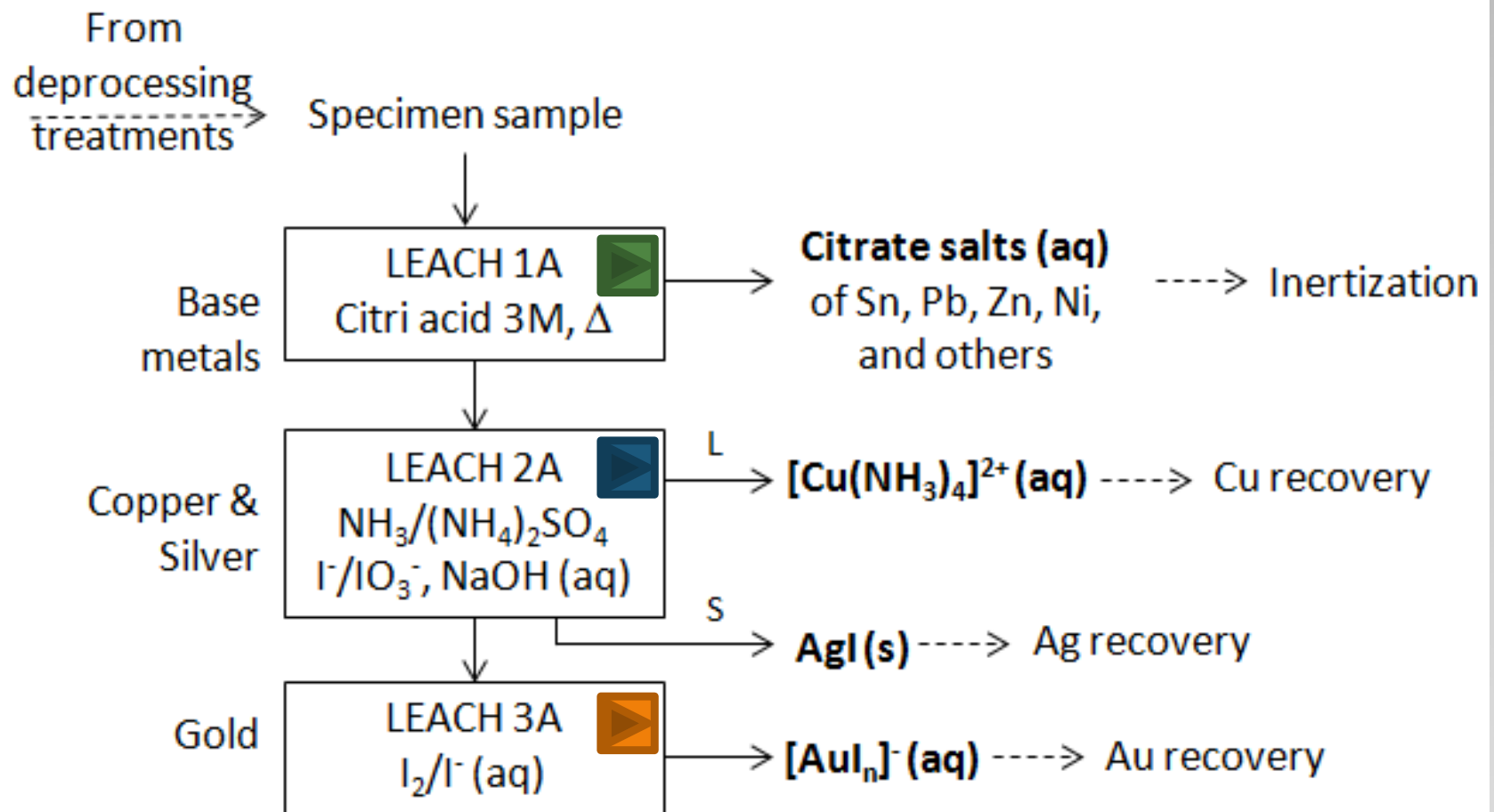
## Phase 2: Test specimen



Me	RAM #R#G#M	Reference sample
		
	% w/w	% w/w
Au	0.08	0.01
Cu	15	79
Ag	0.04	0.06
Ni	4	0.5
Fe	7	1
Cr	0.07	
Mn	0.06	
Pb	0.8	7
Sn	n. a.	10

- **RAM #R#G#M**
  - Coarse material
  - Metallic fraction ~ 30% of the sample
  - Presence of ferrous materials
  - Presence of vitreous-plastic material
  - Low cost pre-treatments
- **Reference sample**
  - Thin powder material
  - Deprived by non-metallic materials
  - Deprived by ferrous materials
  - More costly treatments and equipments

# Reference vs selected sample



## Phase 2: leaching & recovery

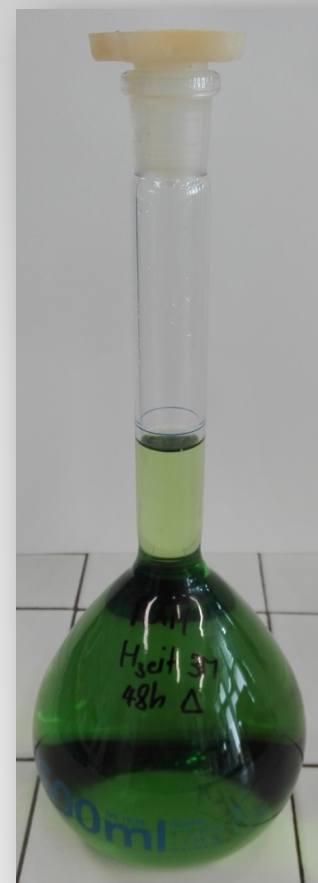
- Base metal dissolution

Leach conditions		Base metals %	Leach. time (ref.)	Leach. time (obs.)	Dissolution Yield
Citric Acid 3M, $\Delta$	A	~20	48h	48h	Almost quantitative
	B	~20	48h	48h	Almost quantitative (+25% Cu)

Sample A: Reference

Sample B: RAM #R#G#M

**Selecity can be improved by tuning the leaching time and working under inert atmosphere ( $N_2$ )**

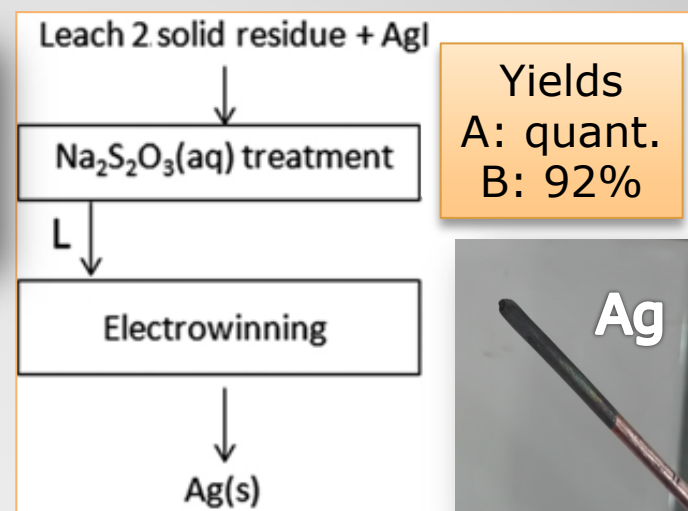
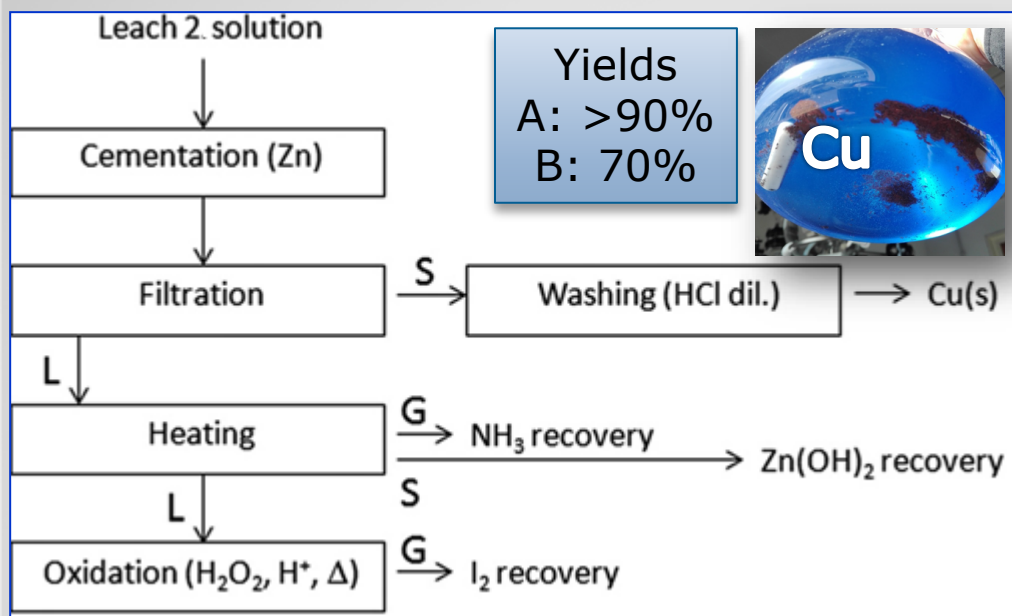


## Phase 2: Leach 1



- Copper and silver dissolution and recovery

Leach conditions		Metals %	Leach. time (ref)	Leach. time (obs.)	Leaching products
NH <sub>3</sub> /(NH <sub>4</sub> ) <sub>2</sub> SO <sub>4</sub> I-/IO <sub>3</sub> <sup>-</sup> (OH <sup>-</sup> )	A	Cu ~80 Ag 0.06	48h	48h	[Cu(NH <sub>3</sub> ) <sub>4</sub> ] <sup>2+</sup> (aq) AgI(s)
	B	Cu ~15 Ag 0.04	9h	96h	

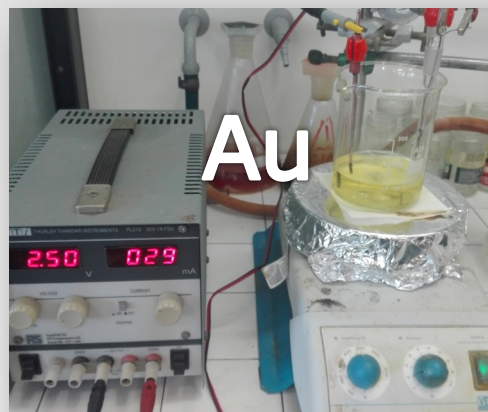
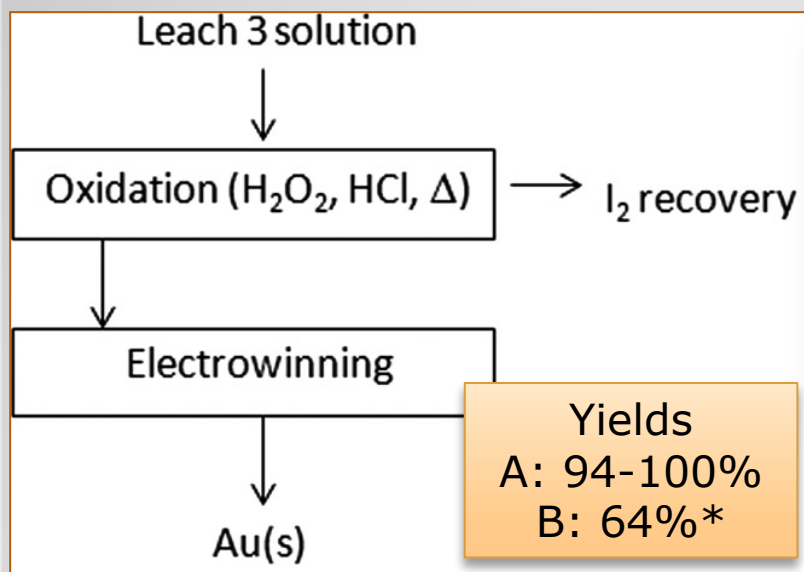


# Phase 2: Leach 2



- Gold dissolution and recovery

Leach conditions		Au %	Leach. time (ref)	Leach. time (obs.)	Leaching products
I <sup>-</sup> /I <sub>2</sub> (aq) 5:1	A	0.01	30'	30'	[AuI <sub>4</sub> ] <sup>-</sup> (aq)
	B	0.08	30'	30'	



\*The solid residue contains the missing 36% of Au, 5% of Cu and a small amount of Ag.

## Phase 2: Leach 3

- As expected, the effectiveness of the process is higher towards the sample A than B, thanks to its greater surface area and limited presence of interfering species.
- Nevertheless, the coarseness of the material does not seem jeopardize the process:
  - Leach 2 (Cu) was the most affected requiring leaching times 10-times longer than expected → gradual exposure of copper hidden by the vitreous-plastic support matrix.
  - A slight further effort in combining the pre-treatment set up with the subsequent leaching processes would help in obtaining the optimal conditions to meet the effectiveness and sustainability required for practical application.

## Conclusions: leaching process

- Systematic characterization of the NM content in different typologies of PCB by quantitative chemical analysis.
- On the basis on the PCBs characterization and the described preliminary results, a scale-up of the process on a pilot scale (**Phase 3**) will be performed thanks to the #Recovery #Green #Metal project supported by companies through the crowdfunding platform [WithYouWeDo](#)



## Conclusions and perspectives



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group**

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Co-founders #Recovery #Green #Metal

TIM, Roma



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Valori e Preziosi, Padova

CO.RE.M. Srl

Oro Market, Mestre (VE)



Ri.Tech, Matera

OMCD, Anzola d'Ossola (VB)

Ecocopper, Carasco (GE)

VALORI e PREZIOSI

CO.RE.M., Sestu (CA)

RI.TECH Srl



# Acknowledgements



Two main alternative approaches “inherited” by ore reclamation:

## 1. **Pyrometallurgical treatments**

- Efficient
- High costs (energy intensive)
- High environmental impact (e.g. gas emissions)
- Unselective

## 2. **Hydrometallurgical methods**

### *Conventional*

Cyanidation in alkaline media

Strong oxidising acids (e.g. aqua regia)

- Relatively selective
- Effective
- Low cost
- Dangerous reagents
- Gas emissions
- Wastewater

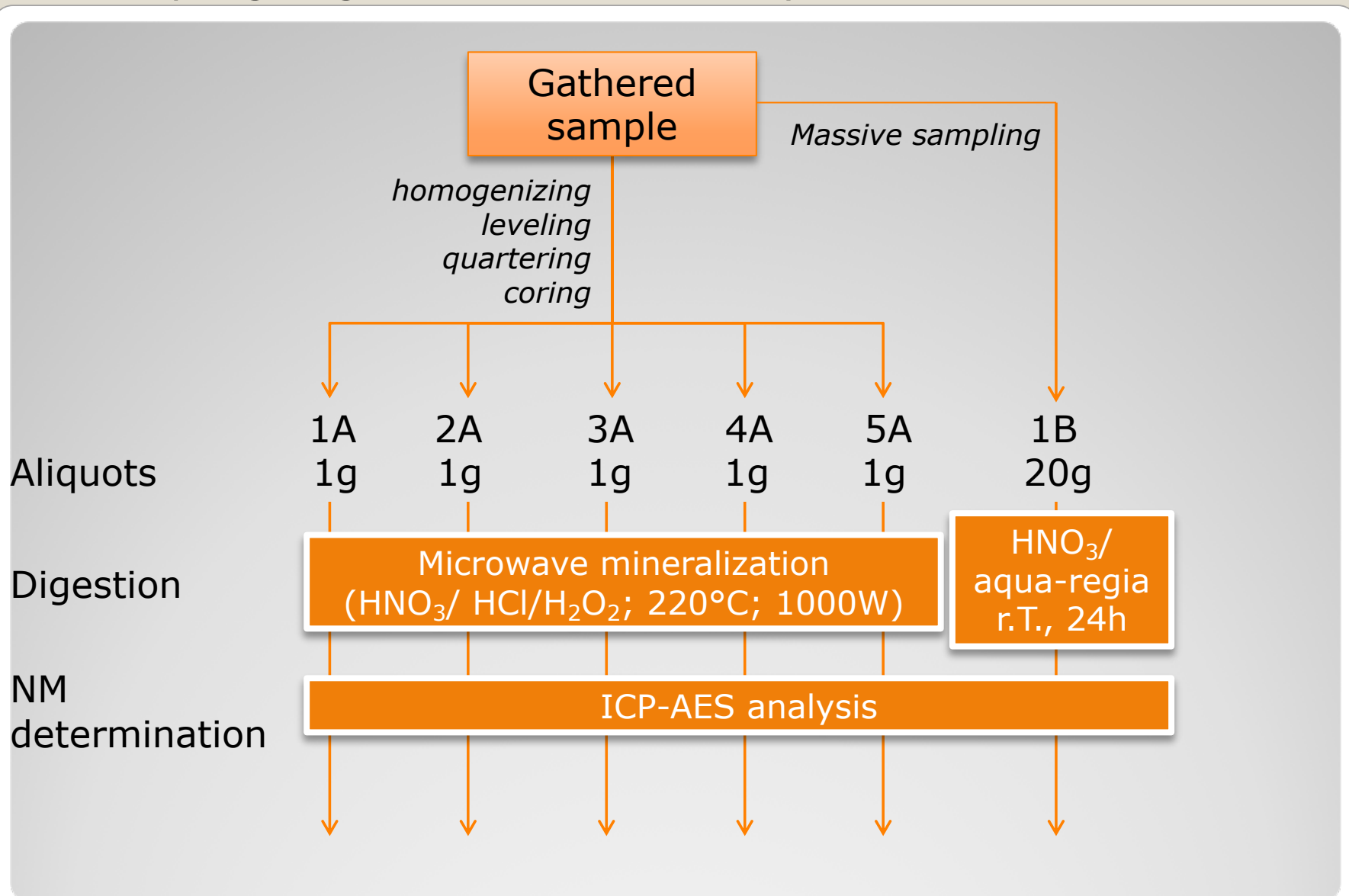
### *Alternative*

Thiosulfate or Thiourea in oxidising environment ( $O_2$ ,  $Fe^{3+}$ , ...)

- Relatively selective
- Effective
- Low cost
- Safer reagents
- High reagent consumption

# Industrial methods for NM recovery

- Sampling, digestion, ICP-AES analysis



# CHARACTERIZATION OF PCBs